

# 5RKA5111P

- Orange LED
- 620 nm, 70-80 cd
- 5 mm Clear Epoxy Resin
- Viewing Angle: 15°

### Description



Rev 2.0, 19.07.2018



**5RKA5111P** contains one LED chip die mounted on a lead frame hermetically sealed with a clear epoxy lens. On forward bias, the typical intensity is **80 cd** at a dominant wavelength at **620 nm**.

### Maximum Ratings (T<sub>CASE</sub>=25°C)

| Parameter                  | Symbol           | Val  | Unit  |      |
|----------------------------|------------------|------|-------|------|
| Farameter                  | Symbol           | Min. | Max.  | Unit |
| Power Dissipation          | PD               |      | 182   | mW   |
| Forward Current            | lF               |      | 70    | mA   |
| Pulse Forward Current *1   | IFP              |      | 120   | mA   |
| Reverse Voltage            | VF               |      | 5     | V    |
| Operating Temperature      | TCASE            | - 30 | + 85  | °C   |
| Storage Temperature        | Tstg             | - 40 | + 100 | °C   |
| Lead Solder Temperature *2 | T <sub>SLD</sub> |      | + 260 | °C   |

\*1 duty=1%, pulse width = 10  $\mu$ s

\*2 must be completed within 3 seconds

# Electro-Optical Characteristics (TCASE=25°C)

| Parameter              | Symbol      | Conditions           | Values |      |      | Unit |
|------------------------|-------------|----------------------|--------|------|------|------|
|                        |             |                      | Min.   | Тур. | Max. | Unit |
| Dominant Wavelength *1 | $\lambda_D$ | I <sub>F</sub> =70mA | 619    | 624  | 629  | nm   |
| Forward Voltage *2     | VF          | I <sub>F</sub> =70mA | 1.8    | 2.5  | 2.9  | V    |
| Reverse Current        | $I_R$       | V <sub>R</sub> =5V   |        |      | 10   | μA   |
| Luminous Intensity *3  | $I_V$       | I⊧=70mA              | 70     | 80   |      | cd   |
| Viewing Angle          | φ           | I <sub>F</sub> =70mA |        | 15   |      | deg. |

\*1 tolerance: ±1 nm

\*2 tolerance: ±15%

\*3 tolerance: ±0.1 V



# Typical Performance Curves



# **Outline Dimensions**



All Dimensions in mm Tolerance: ±0.3 mm



# Precautions

#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering
- Do not solder the LED closer than 3 mm from the base of the lead.

#### **Recommended soldering conditions:**



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### Cleaning:

#### Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

#### Static Electricity:

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### **Radiation:**

During operation LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light wear protective glasses, if needed. It is further advised to attach a warning label on products/systems.

#### **Operation:**

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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